

BS170 MOSFET N-Ch, Enhancement Mode High Speed Switch TO92 Type Package

<u>Absol</u>	ute	Maxi	mum	Rating	qs:
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Drain-Source Voltage, V _{DS}	60V
Gate-Source Voltage, V _{GS}	±20V
Drain Current (Note 1), I _D	500mA
Total Device Dissipation (T _A = +25°C), P _D	350mW
Operating Junction Temperature Range, T _J	–55° to +150°C
Storage Temperature Range, T _{stg}	–55° to +150°C

Note 1. The Power Dissipation of the package may result in a lower continuous drain current.

<u>Electrical Characteristics:</u> $(T_A = +25^{\circ}C \text{ unless otherwise specified})$

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit				
OFF Characteristics										
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0$, $I_D = 100 \mu A$	60	90	_	V				
Gate Reverse Current	I _{GSS}	V _{GS} = 15V, V _{DS} = 0	_	0.01	10	nA				
ON Characteristics (Note 2)			•							
Gate Threshold Voltage	V _{GS(Th)}	$V_{DS} = V_{GS}$, $I_D = 1mA$	0.8	2.0	3.0	V				
Static Drain-Source ON Resistance	r _{DS} (on)	V _{GS} = 10V, I _D = 200mA	_	1.8	5.0	Ω				
Drain Cutoff Current	I _{D(off)}	V _{DS} = 25V, V _{GS} = 0	_	_	0.5	μΑ				
Forward Transconductance	9 _{fs}	V _{DS} = 10V, I _D = 250mA	_	200	_	mmhos				
Small-Signal Characteristics										
Input Capacitance	C _{iss}	V _{DS} = 10V, V _{GS} = 0, f = 1MHz	_	_	60	pF				
Switching Characteristics										
Turn-On Time	t _{on}	I _D = 200mA	_	4	10	ns				
Turn-Off Time	t _{off}	I _D = 200mA	-	4	10	ns				

Note 2. Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2\%$.

